

/ Revised record



silicon NPN and PNP transistor in a SOT-363 Plastic Package

With built-in bias resistors, simplify circuit design, reduce a quantity of parts and manufacturing process, Halogen-free Product.





/ Electrical Characteristic Curve(PNP)





/ Marking Instructions

H313^{*}
*



" 1 "

H313

***.

Note:



"1" Pin

H313

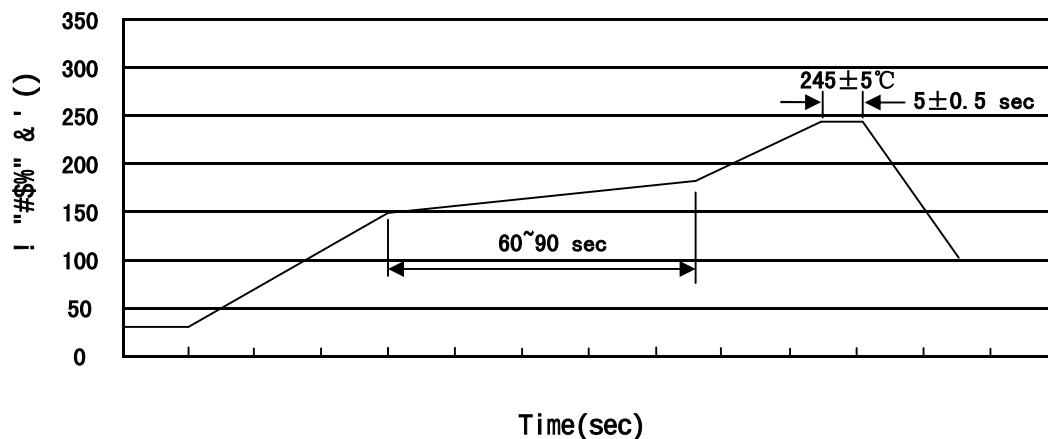
Product Type Code

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Lot No. Code, code change with Lot No.



() / Temperature Profile for IR Reflow Soldering(Pb-Free)



Note:

1. Preheating: 150~180°C, Time: 60~90sec.
2. Peak Temp.: 245±5°C, Duration: 5±0.5sec.
3. Cooling Speed: 2~10°C/sec.

/ Resistance to Soldering Heat Test Conditions

260±5°C 10±1 sec. Temp.: 260±5 Time: 10±1 sec

/ Packaging SPEC.

/ REEL

Package Type	Units " # \$					Dimension " % & (unit ' mm ³)		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box (	Outer Box)
SOT-363	3,000	10	30,000	6	180000	7" x8	180×120×180	390×385×205

/ Notices